Input Voltage = 4.5Vin to 55Vin

-5Vout @ 1.75A
### Label Table

<table>
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PCB Number: TIDA-00808  
PCB Rev: E1  

Texas Instruments  
Pb-Free Symbol

PCB
Logo

PCB
Logo

PMTS 440 0025 PH

PMTS 440 0025 PH

PMTS 440 0025 PH

PMTS 440 0025 PH

H1

H2

H3

H4

H5

H6

H7

H8

1902C

1902C

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DNP

DNP

DNP

DNP

FID1

FID2

FID3

FID4

CO!PCB1

COFID1

COFID2

COFID3

PIH101

PIH201

PIH301

PIH401

COH1

COH2

COH3

COH4

COH5

COH6

COH7

COH8

COLogo1

COLogo2
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